

# CLEANING LABORATORY EVALUATION SUMMARY

SCL #: 2008  
DateRun: 02/22/2008  
Experimenters: Heidi Wilcox, Shweta Bansal  
ClientType: Electronics Manufacturer  
ProjectNumber: Project #1  
Substrates: Copper  
PartType: Coupon  
Contaminants: Oil  
Cleaning Methods: Mechanical Agitation  
Analytical Methods: Gravimetric  
Purpose: To evaluate possible alternatives for solvent cleaning of oil

**Experimental Procedure:** Four new product samples of solvents used for hand dipping applications at room temperature were chosen for testing as a Possible substitute for the clients current cleaning solvent.

Twelve preweighed coupons were coated with Hangsterfer Laboratories Hard Cut 5418 cutting fluid using a handheld swab. The contaminated coupons were weighed a second time to determine the amount of soil added. Three coupons were immersed into each cleaning solution and manual raised and lowered in the cleaning solution to provide minimal mechanical agitation. After one minute of cleaning, the coupons were removed and dried for 30 seconds using compressed air at room temperature. Following air drying, the coupons were weighed a final time to determine the amount of soil remaining. Efficiency for each coupon was determined and average cleaning results for each product were calculated.

**Results:** All four products removed over 99% of the cutting fluid within one minute of mechanical agitation. The table below lists the amount of soil added, the amount remaining and the efficiency for each coupon cleaned.

| Cleaner   | Initial wt | Final wt | % Removed |
|-----------|------------|----------|-----------|
| Dysol 104 | 0.0905     | 0.0000   | 100.00    |
|           | 0.3772     | 0.0001   | 99.97     |
|           | 0.1678     | 0.0000   | 100.00    |
| Dysol 108 | 0.2693     | 0.0001   | 99.96     |
|           | 0.1535     | 0.0000   | 100.00    |
|           | 0.2320     | 0.0001   | 99.96     |
| Dysol 144 | 0.2583     | 0.0000   | 100.00    |
|           | 0.2907     | 0.0001   | 99.97     |
|           | 0.2034     | 0.0000   | 100.00    |
| Dysol 800 | 0.3171     | 0.0000   | 100.00    |
|           | 0.2847     | 0.0000   | 100.00    |
|           | 0.2142     | 0.0001   | 99.95     |

**Summary:**

|                      |                      |               |                    |                                     |                      |
|----------------------|----------------------|---------------|--------------------|-------------------------------------|----------------------|
| <b>Substrates:</b>   | Copper               |               |                    |                                     |                      |
| <b>Contaminants:</b> | Oil                  |               |                    |                                     |                      |
| <b>Company Name:</b> | <b>Product Name:</b> | <b>Conc.:</b> | <b>Efficiency:</b> | <b>Effective:</b>                   | <b>Observations:</b> |
| Dysol                | DS 104 Wipe Solvent  | 100           | 99.99              | <input checked="" type="checkbox"/> |                      |
| Dysol                | DS 108 Wipe Solvent  | 100           | 99.97              | <input checked="" type="checkbox"/> |                      |
| Dysol                | DS 144S Wipe Solvent | 100           | 99.99              | <input checked="" type="checkbox"/> |                      |
| Dysol                | DS 800 Solvent       | 100           | 99.98              | <input checked="" type="checkbox"/> |                      |

**Conclusion:** The four products will be used in further testing on client supplied parts.